

A precise digitization of Si detectors

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Introduction

overview of the Si detector and digitization
key issues in digitization

the 1st version code

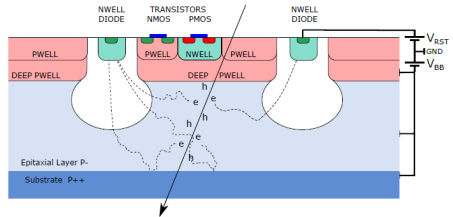
condition
implement

result

resolution simulation

principle of Si detector

- ▶ pixel detector
 - ▶ CMOS
 - ▶ SOI
 - ▶ hybrid
 - ▶ DEPFET
- ▶ micro strip detector

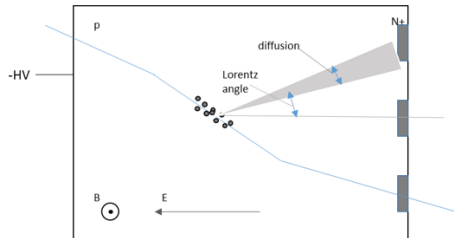


process of digitization^[1]

- ▶ *SimTrackHits* → *TrackerPluser* → *TrackerHits* → *Clustering*
 - ▶ SimTrackerHits: the hits in Mokka(center point of each step)
 - ▶ TrackerPluser: the charge collected in the diode(transport of electrons and holes)
 - ▶ TrackerHits: a cluster of hitting pixels(electric noise ENC)
 - ▶ Clustering: the final position(special algorithm)

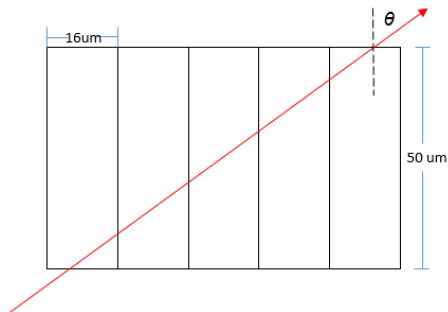
transport of electron and hole

- ▶ Drift and Diffusion
 - ▶ Drift: main power of charge collection
 - ▶ Diffusion: main reason for a cluster in small incidence angle
- ▶ Lorentz angle
 - ▶ $\tan(\theta) = \mu_H \times B$



readout and algorithm

- ▶ analog readout
 - ▶ COG algorithm: when the cluster size ≤ 2
 - ▶ η algorithm: when the energy deposited is nonlinear and cluster size ≤ 2
 - ▶ head-tail algorithm: when the cluster size > 2
- ▶ digital readout
 - ▶ don't find algorithms specially for digital readout
 - ▶ may be deduced from analog algorithm



condition

- ▶ detector model: P-N junction
- ▶ Lorentz angle: 10 degree
- ▶ noise and threshold are considered
 - ▶ threshold = $5 \times$ noise
- ▶ algorithm
 - ▶ analog: COG and head-tail
 - ▶ digital: head-tail
- ▶ very primary!

SimTrackHits → *TrackerPluser*

- ▶ get hit track from VXDCollection
- ▶ calculate the number of electrons ionizing from the track(Poisson sampling)
 - ▶ $N_{electron} = \frac{EDep}{3.65eV}$
- ▶ For every electron calculate the final position when it reaches the surface of sensitive layer
- ▶ Map all the electrons to pixel array, calculate pixel center and electron numbers it collects.

TrackerPluser → *TrackerHits*

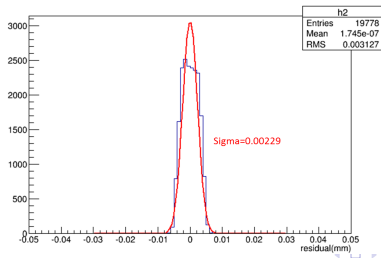
- ▶ get the cluster of hitting pixels
- ▶ smear electron numbers with ENC(noise in e^-)
- ▶ compare with the threshold(e^-),if $>$ threshold, the number will be set to 1, else to 0

TrackerHits → Clustering

- ▶ use head-tail algorithm to calculate the final position
 - ▶ $x_{hit} = \frac{x_{min} + x_{max}}{2}$ (x_{min}, x_{max}) present the leftmost and rightmost pixels
 - ▶ $y_{hit} = \frac{y_{min} + y_{max}}{2}$ (y_{min}, y_{max}) present the leftmost and rightmost pixels

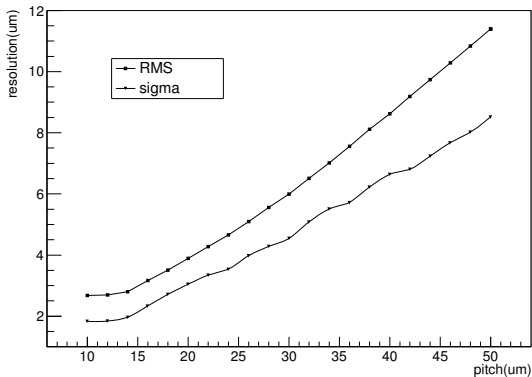
resolution

- ▶ condition
 - ▶ 50000 10GeV μ^- , normal incidence, pitch=16 μ m, T=300K, ENC=20 e^- , Threshold=100 e^- , digital readout
 - ▶ cut: $-0.05\text{mm} < \text{residual} < 0.05\text{mm}$
- ▶ result in local coordinate
 - ▶ Residual = detector measured position – actual position



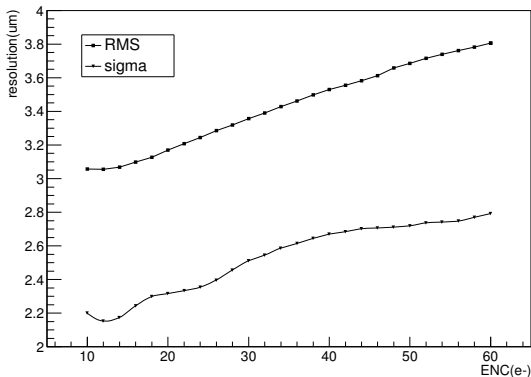
resolution

- ▶ change along with pixel pitch



resolution

- ▶ change along with ENC



formula of electron's transportation

$$\mu(x) = \frac{\mu_0}{\left(1 + \left(\frac{E(x)}{E_c}\right)^\beta\right)^{\frac{1}{\beta}}}$$

$$v(x) = \mu(x)E(x)$$

$$t = \int \frac{1}{v(x)} dx$$

$$\sigma = \sqrt{2Dt} \quad \text{while} \quad D = \frac{kT}{q} \mu(\bar{x})$$

- ▶ $E(x)$: the electric field
- ▶ μ : electron mobility
- ▶ t : drift time
- ▶ D : diffusion coefficient
- ▶ σ : cluster size

transportation equation for P-N junction model

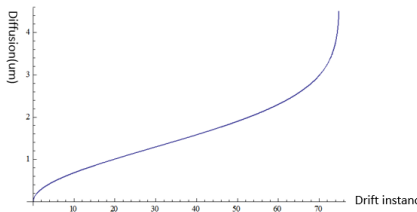
- ▶ P-N junction electric field

$$E_{pn}(x)$$

- ▶ $E_{pn}(x) = \frac{qN}{\epsilon}(x - W)$
- ▶ $\mu(x) = \mu_0$

- ▶ $t = \int_{x_0}^0 \frac{dy}{\mu_0 E(x)} = \frac{\epsilon}{qN\mu} \ln\left(\frac{W}{W-x_0}\right)$

- ▶ $\sigma = \sqrt{\frac{2\epsilon kT}{q^2 N} \ln\left(\frac{W}{W-x_0}\right)}$



algorithm^[2]

- ▶ COG algorithm

- ▶ $x_{COG} = \frac{\sum_{cluster} x_i q_i}{\sum_{cluster} q_i}$

- ▶ η algorithm

- ▶ $x_\eta = x_{left} + pitch \frac{\int_0^{\eta_0} \frac{dN}{d\eta} d\eta}{\int_0^1 \frac{dN}{d\eta} d\eta}$ while $\eta = \frac{q_R}{q_R + q_L}$

- ▶ head-tail algorithm

- ▶ $x_{headtail} = \frac{x_R + x_L}{2} + \frac{q_R - q_L}{2q_{in}} pitch$

silicon detector parameters^[3, 4, 5, 6, 7, 8, 9, 10]

type	name	pitch	thickness	efficiency	power	cluster	resolution	fake hit	frequency
HV-CMOS	-	21um	50um	98%	3.05uW/pixel	6pixels	3um	-	20KHz
CMOS	ALPIDE	30um	50um	99%	40mW/cm. ²	2-3pixels	5um	$< 10^{-6}$	100KHz
CMOS	MIMOSA	21um	50um	99.5%	150mW/cm. ²	5 x 5pixels	4um	$< 10^{-4}$	5KHz
DEPFET	-	50um	50um	100%	5W	1-2pixels	9um	-	50KHz
SOI	CPV	16um	75um	100%	-	-	-	-	-



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Published online at [jA](#)

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